

## CALENDAR

**Upcoming: June 5–8 E-MRS Spring Meeting, E-MRS; June 24–27 2001 International Workshop on Superconductivity (ISTEC), MRS; July 1–6 Conf. on Advances in Environmental Materials, and Intl. Conf. on Materials for Advanced Technologies, MRS-S; 4th Intl. Conf. on Nitride Semiconductors, MRS.**

To list an event in the Calendar, contact J. Meiksin, Materials Research Society, 506 Keystone Drive, Warrendale, PA 15086-7573; 724-779-3004 ext. 522; fax 724-779-8313.

**MRS, A-MRS, C-MRS, E-MRS, MRS-A, MRS-I, MRS-J, MRS-K, MRS-R, MRS-S, MRS-T, M-MRS, or IUMRS at the end of an entry indicates sponsorship or co-sponsorship of an event by the International Union of Materials Research Societies or one of its adhering bodies. "Endorsed" identifies events endorsed by MRS.**

▼ identifies a new or revised entry this month.

See the March 2001 MRS BULLETIN for May 2001 Calendar entries.

### JUNE 2001

**3–6** Symposium on New Technology in Computer Applications for the Steel Industry, *Myrtle Beach, SC*. Iron & Steel Society, 186 Thorn Hill Rd., Warrendale, PA 15086-7528; 724-776-1535; fax 724-776-0430; e-mail custserv@iss.org; www.iss.org.

**3–8** ▼ 32nd Society for Information Display Annual Symposium, *San Jose, CA*. M. Goldfarb, Palisades Convention Mgmt., 411 Lafayette St., 2nd Floor, New York, NY 10003; 212-460-8090; fax 212-460-5460; e-mail mgoldfarb@pcm411.com.

**3–8** Conf. on Structure and Mechanical Properties of Nanostructured Materials, *Barga, Italy*. The United Engineering Foundation, 3 Park Ave., 27th Floor, New York, NY 10016-5902; 212-591-7836; fax 212-591-7441; e-mail engfnd@aol.com; www.engfnd.org.

**4–6** ▼ ATP Natl. Meeting: Funding Opportunities for High-Risk Research, *Baltimore, MD*. Conf. Office, Natl. Inst. of Standards and Technology, 100 Bureau Dr., Stop 3461, Gaithersburg, MD 20899-3461; 1-800-287-3863; fax 301-948-2067; e-mail atp@nist.gov; www.nist.gov/conferences.

**4–7** 10th Intl. Workshop on Critical Currents, *Göttingen, Germany*. H.C. Freyhardt, Inst. für Materialphysik Windausweg 2, 37073 Göttingen, Germany; 49-551-50717-0; fax 49-551-50717-50; e-mail hfreyha@gwdg.de; www.iwcc2001.uni-goettingen.de.

**5–7** PLASTEC™ East Plastics Conf., co-located with Medical Design & Manufacturing East and Atlantic Design & Manufacturing Conf., *New York, NY*. Canon Communications, 11444 W. Olympic Blvd., Ste. 900, Los Angeles, CA 90064; 310-996-9447; 310-996-9499; www.canontradeshows.com.

**5–8** E-MRS Spring Meeting, *Strasbourg, France*. E-MRS, B.P. 20, 67037 Strasbourg Cedex 2, France; 33-3-8810-6372; fax 33-3-8810-6343; e-mail emrs@phase.c-strasbourg.fr; www-emrs.c-strasbourg.fr. E-MRS.

**6–8** Conf. on Optical Engineering for Sensing and Nanotechnology, *Yokohama, Japan*. SPIE, P.O. Box 10, Bellingham, WA 98227-0010; 360-676-3290; fax 360-647-1445; e-mail spie@spie.org; www.spie.org.

**10–13** 75th ACS Colloid and Surface Science Symposium, *Pittsburgh, PA*. S. Garoff, 412-268-6877; fax 412-681-0648; e-mail sg2e@andrew.cmu.edu; http://colloids2001.cheme.cmu.edu.

**10–13** ▼ Intl. Conf. on Biofouling and Materials, *Frankfurt am Main, Germany*. W. Furbeth, Elektrochemie und Korrosion, Theodor-Heuss-Allee 25, D-60486 Frankfurt am Main, Germany; 49-69-7564-398; fax 49-69-7564-388; www.dechema.de/biofouling.

**10–14** EUROMAT 2001 Conf., *Rome, Italy*. AIM, Piazzale Rodolfo Morandi 2-1-20121 Milano, Italy; 39-2-7639-7770; fax 39-2-7602-0551; e-mail aim@fast.mi.it; www.fast.mi.it/aim/euromat.htm.

**10–15** ▼ NATO Advanced Research Workshop on Frontiers of High-Pressure Research II: Application of High Pressure to Low-Dimensional Novel Electronic Materials, *Ft. Collins, CO*. H.D. Hochheimer, Dept. of Physics, Colorado State Univ., Ft. Collins, CO 80523; 970-491-6246; fax 970-491-7947; e-mail dieter@lamar.colostate.edu; http://lamar.colostate.edu/~natoarw/.

**11–15** Natl. Space and Missile Materials Symposium, *Monterey, CA*. Space and Missile Materials Symposium, c/o Anteon Corp., 5100 Springfield St., Ste. 509, Dayton, OH 45431; 937-254-7950; fax 937-253-2296; e-mail diana.carlin@kirtland.af.mil; www.usasymposium.com/space2/index.htm.

**13-15** 3rd Intl. Symposium on Acid-Base Interactions, *Newark, NJ*. R.H. Lacombe, Conf. Chairman, 3 Hammer Dr., Hopewell Junction, NY 12533; 845-226-1393; fax 212-656-1016; e-mail rhl@msstconf.com; http://msstconf.com/acidbase3.htm.

**13-15** 6th Intl. Symposium on Sputtering and Plasma Processes, *Kanazawa, Japan*. E. Kusano, ISSP 2001 Committee, Advanced Materials Science Ctr., Kanazawa Inst. of Technology, 3-1 Yatsukaho Matto, Ishikawa 924-0838, Japan; 81-76-274-9250; fax 81-76-274-9251; e-mail issp@www.kanazawa-it.ac.jp; www.kanazawa-it.ac.jp/issp/.

**17-20** 5th Intl. Special Emphasis Symposium on Superalloys 718, 625, 706, and Derivatives, *Pittsburgh, PA*. TMS, 184 Thorn Hill Rd., Warrendale, PA 15086; 724-776-9000; fax 724-776-3770; e-mail tmsgeneral@tms.org; www.tms.org/cms.

**18-20** 2nd Intl. Conf. on Cellular Metals and Metal Foaming Technology, *Bremen, Germany*. Fraunhofer-Inst. IFAM, MetFoam 2001 Conf. Secretariat, Wiener Str. 12, D-28359 Bremen, Germany; 49-421-2246-0; fax 49-421-2246-300; e-mail metfoam@ifam.fhg.de; www.ifam.fhg.de.

**18-20** 3rd Intl. Symposium on Silanes and Other Coupling Agents, *Newark, NJ*. R.H. Lacombe, Conf. Chairman, 3 Hammer Dr., Hopewell Junction, NY 12533; 845-226-1393; fax 212-656-1016; e-mail rhl@msstconf.com; http://msstconf.com/silane3.htm.

**18-20** 7th Intl. Electric and Machines Drives Conf., *Cambridge, MA*. IEMDC 2001 Conf., Courtesy Associates, 2000 L St. N.W., Ste. 710, Washington, DC 20036; 202-973-8682; fax 202-331-0111; e-mail iemdc@courtesyassoc.com; http://power.mit.edu/IEMDC.

**18-21** 7th Intl. Conf. on Architectural and Automotive Glass, *Tampere, Finland*. J. Vitkala, Conf. Chairman, Tamglass Ltd. Oy, Vehmaistenkatu 5, 33730 Tampere, Finland; 358-3-372-3111; fax 358-3-372-3180; e-mail jorma.vitkala@tamglass.com; www.glassprocessingdays.com.

**18-22** Particle Accelerator Conf., *Chicago, IL*. C. Eyberger, Conf. Coordinator, Argonne Natl. Lab., Bldg. 401, 9700 S. Cass Ave., Argonne, IL 60439; 630-252-7575; fax 630-252-1512; e-mail pac2001@aps.anl.gov.

**19-21** 6th Intl. Workshop on Plasma-Based Ion Implantation, *Grenoble, France*. Y. Pauleau, CNRS-LEMD, B.P. 166, 25 Rue des Martyrs, 38042 Grenoble Cedex 9, France; 33-4-7688-1071; fax 33-4-7688-7945; e-mail pauleau@polycnrs-gre.fr; www.polycnrs-gre.fr.

**20-22** Conf. on Laser and Laser Information Technology, *Vladimir, Russia*. SPIE, P.O. Box 10, Bellingham, WA 98227-0010; 360-676-3290; fax 360-647-1445; e-mail spie@spie.org; www.spie.org.

**23-30** 12th APS Topical Conf. on Shock Compression of Condensed Matter, *Atlanta, GA*. A. Roach, Los Alamos Natl. Lab.; 505-665-6277; e-mail alita@lanl.gov.

**24-27** 2001 International Workshop on Superconductivity (ISTEC), *Honolulu, Hawaii*. Workshop Coordinators: Tetsuji Kobayashi, ISTEC and Elton N. Kaufmann, Argonne National Laboratory; fax 81-3-3431-4044; e-mail t-kobayashi@istec.or.jp; www.istec.or.jp/ISTEC\_homepage/WORK/e-workshop.html. **MRS.**

**24-29** 12th APS Topical Conf. on Shock Compression of Condensed Matter, *Atlanta, GA*. A. Roach, Los Alamos Natl. Lab., Los Alamos, NM; 505-665-6277; e-mail alita@lanl.gov.

**24-29** Gordon Research Conf. on Three-Dimensional Electron Microscopy, *Bristol, RI*. Gordon Research Conferences, P.O. Box 984, West Kingston, RI 02892-0984; 401-783-4011; fax 401-783-7644; e-mail grc@grcmail.grc.uri.edu; www.grc.uri.edu.

**24-30** 6th Intl. Workshop on High-Temperature Superconductors and Novel Inorganic Materials Engineering, *Moscow-St. Petersburg, Russia*. R.V. Shpanchenko, MSU-HTSC VI Secretariat, Dept. of Chemistry, Moscow State Univ., 119899 Moscow, Russia; 7-095-939-3490; fax 7-095-939-4788; e-mail roms@icr.chem.msu.ru; http://icr.chem.msu.ru/htsc6.htm.

**25-27** 59th Annual Device Research Conf., *Notre Dame, IN*. A. Seabaugh, Univ. of Notre Dame, Dept. of Electrical Engineering, 266 Fitzpatrick Hall, Notre Dame, IN 46556; 219-631-4473; fax 219-631-4393; e-mail seabaugh.1@nd.edu; www.tms.org/Meetings/Specialty/DRC/2001/DRC-2001-Home.html.

**25-27** Intl. Workshop on Nanocapillarity: Wetting of Heterogeneous Surfaces and Porous Solids, *Princeton, NJ*. e-mail info@trippinceton.org; www.trippinceton.org/workshop2001.

**25-28** 2nd European Cells and Materials Meeting, *Davos, Switzerland*. Conf. Secretary, AO ASIF Research Inst., Clavadelerstrasse, CH7270, Davos Platz, Switzerland; www.aosif.ch/events/other/ecm/index.shtml.

**25-28** Natl. Space and Missile Materials Symposium, *Monterey, CA*. Space and Missile Symposium, c/o Anteon Corp., 5100 Springfield St., Ste. 509, Dayton, OH 45431; 937-254-7950; fax 937-253-2296; www.usasymposium.com.

**26-1** 17th Intl. Conf. on Coherent and Nonlinear Optics, *Minsk, Belarus*. SPIE, P.O. Box 10, Bellingham, WA 98227-0010; 360-676-3290; fax 360-647-1445; e-mail spie@spie.org; www.spie.org.

**27-29** Conf. on Mechanics and Materials, *San Diego, CA*. L. Jacobs-Cohants, Univ. of California at San Diego, Ctr. of Excellence for Advanced Materials, 9500 Gilman Dr., La Jolla, CA 92093-0416; 858-534-4772; fax 858-534-2727; e-mail ljacobs@halebopp.ucsd.edu; www.ceam.ucsd.edu/mmc2001.

**27-29** Electronic Materials Conf., *Notre Dame, IN*. TMS, 184 Thorn Hill Rd., Warrendale, PA 15086; 724-776-9000; fax 724-776-3770; e-mail tmsgeneral@tms.org; www.tms.org/cms.

## JULY 2001

**1-6** Conf. on Advances in Environmental Materials, and Intl. Conf. on Materials for Advanced Technologies, *Singapore*. E-mail tjwhite@eti.org.sg; www.mrs.org.sg/icmat2001. **MRS-S.**

**1-6** Gordon Research Conf. on Materials Processes Far from Equilibrium, *Andover, NH*. Gordon Research Conferences, Univ. of Rhode Island, P.O. Box 984, West Kingston, RI 02892-0984; e-mail app@grcmail.grc.uri.edu; www.grc.uri.edu/regpay/reg.htm.

**1-6** Intl. Gordon Research Conf. on Molybdenum & Tungsten Enzymes, *Oxford, UK*. Gordon Research Conferences, P.O. Box 984, West Kingston, RI 02892-0984; 401-783-4011; fax 401-783-7644; e-mail grc@grcmail.grc.uri.edu; www.grc.uri.edu.

**2-6** Conf. on Coatings Science and Technology, *Athens, Greece*. Inst. of Materials Science, Div. of Program Organization, P.O. Box 369, New Paltz, NY 12561; 845-255-0757; fax 845-255-0978; e-mail info@ims-np.org; http://ims-np.org/.

**2-6** Conf. on Electric Charges in Nonconductive Materials, *Tours, France*. SFV Div. Dielectriques, 19 Rue du Renard, 75004 Paris, France; 33-153-019-030; fax 33-142-786-320; e-mail sfv@vide.org; www.vide.org/CSC4.html.

**2-6** Intl. Conf. on Fuel Cells, *Lucerne, Switzerland*. European Fuel Cell Forum, P.O. Box 99, CH-5452 Oberrohrdorf, Switzerland; 41-56-496-7292; fax 41-56-496-4412; e-mail info@efcf.com; www.efcf.com.

**8-13** Intl. Gordon Research Conf. on Biodegradable Polymers, *Oxford, UK*. Gordon Research Conferences, P.O. Box 984, West Kingston, RI 02892-0984; 401-783-4011; fax 401-783-7644; e-mail grc@grcmail.grc.uri.edu; www.grc.uri.edu.

**10-14** 3rd Intl. Workshop on Current Problems in Complex Fluids: Self-Assembling Systems, *Oaxaca, Mexico*. C. Varea, Inst. de Física, Univ. Nacional Autónoma de México, Apartado Postal 20-364, México, D.F., 01000, México; fax 525-622-5008; http://varea.ifisicacu.unam.mx/Homepage\_archivos/STATPHYS21oaxaca.htm.

**15-21** 21st IUPAP Intl. Conf. on Statistical Physics, *Cancun, Mexico*. A. Robledo, IFUNAM, Apartado Postal 20-364, Mexico 01000, D.F., Mexico; 525-622-5095; fax 525-622-5008; e-mail statphys@varea.ifisicacu.unam.mx; http://varea.ifisicacu.unam.mx/statphys21.htm.

**16-20** 4th Intl. Conf. on Nitride Semiconductors (ICNS-4), *Denver, CO*. Materials Research Society, 506 Keystone Drive, Warrendale, PA 15086; 724-779-3003; fax 724-779-8313; e-mail info@mrs.org.; www.mrs.org. **MRS.**

**16-20** 21st Int. Conf. on Defects in Semiconductors, *Giessen, Germany*. ICDS 21, D. Musaeus, I. Physikalisches Inst., Heinrich-Buff-Ring 16, D-35392 Giessen, Germany; e-mail ICDS21@physik.uni-giessen.de; www.uni-giessen.de/icds21.

**16-20** Cryogenic Engineering Conference & International Cryogenic Materials Conference (CEC-ICMC), *Madison, WI*. Centennial Conferences, 4800 Baseline Road, A-112, Boulder, CO 80303 USA; 303-499-2299; fax 303-499-2599; e-mail cec-icmc@centennialconferences.com; www.cec-icmc.org

**18-24** 22nd Intl. Conf. on Photonic, Electronic, and Atomic Collisions, *Santa Fe, NM*. S. Datz, Oak Ridge Natl. Lab., P.O. Box 2008, Oak Ridge, TN; 865-574-4984; fax 865-574-1118; e-mail icpeac@phy.ornl.gov; http://icpeac2001.phy.ornl.gov.html.

**21-26** Natl. Meeting of the American Crystallographic Association, *Los Angeles, CA*. D. McRee, Dept. of Molecular Biology, Scripps Research Inst., La Jolla, CA 92037; 619-784-9235; fax 619-784-2857; e-mail dem@scripps.edu; www.hwi.buffalo.edu/ACA/ACA-Annual/LosAngeles/LosAngeles.html.

**22-26** 10th Intl. Conf. on Intergranular and Interphase Boundaries, *Haifa, Israel*. W. Kaplan, Dept. of Materials Engineering, Technion, Israel Inst. of Technology, Haifa 32000, Israel; 972-4-829-4580; fax 972-4-832-1978; e-mail kaplan@tx.technion.ac.il; http://iib2001.technion.ac.il.

**23-27** 13th Intl. Conf. on Vacuum UV Radiation Physics, *Trieste, Italy*. e-mail renato.gioppo@elettra.trieste.it; vuv13.elettra.trieste.it/vuv13/.

**23-27** Intl. Conf. on Applied Statistical Physics: Molecular Engineering, *Cancun, Mexico*. Secretariat, Mexican Academy of Molecular Engineering, Piso 12, Torre Ejecutiva, Inst. Mexicano del Petroleo, Eje Central Lazaro Cardenas 152, Col. San Bartolo Atepehuacan, C.P. 07730, Mexico, D.F.; 525-333-6240; fax 525-333-6239; e-mail info@aspm2001.com.mx; www.aspm2001.com.mx.

**25-27** 6th Intl. Workshop on Stress-Related Effects in Metallizations, *Ithaca, NY*. Stress Workshop, Bard Hall, Cornell Univ., Ithaca, NY 14853; 607-255-4135; fax 607-255-2365; e-mail stressworkshop@cornell.edu; http://stressworkshop.cornell.edu.

**29-3** 19th Intl. Conf. on Atomic Collisions in Solids, *Paris, France*. V.A. Esaulov, Lab. des Collisions Atomiques et Moléculaires, Bat. 351, Univ. de Paris Sud, 91405 Orsay Cedex, France; 33-69-15-76-80; fax 33-69-15-76-71; e-mail icacs19@veof1.icam.u-psud.fr; http://veof1.icam.u-psud.fr/idc/icacs19.html.

**29-3** 28th Annual Review of Progress in Quantitative Nondestructive Evaluation, *Brunswick, ME*. L. Poore; 515-294-6770; fax 515-294-7771; e-mail qnde3@cnde.iastate.edu.

**29-3** Intl. Conf. on High-Performance Materials in Bridges and Buildings, *Kona, HI*. United Engineering Foundation, 3 Park Ave., 27th Floor, New York, NY 10016-5902; 212-591-7836; fax 212-591-7441; e-mail engfnd@aol.com; www.engfnd.org.

**29-3** SPIE Annual Meeting and Intl. Symposium on Optical Science and Technology, *San Diego, CA*. SPIE, P.O. Box 10, Bellingham, WA 98227-0010; 360-676-3290; fax 360-647-1445; e-mail spie@spie.org; www.spie.org.

**30-3** 4th Intl. Conf. on Biological Physics, *Kyoto, Japan*. M. Go, Div. of Biological Science, Graduate School of Science, Nagoya Univ., Furo-cho, Chikusa-ku, Nagoya 464-8602, Japan; e-mail icbp2001@kokusai.phys.nagoya-u.ac.jp; kokusai.phys.nagoya-u.ac.jp/.

**30-3** ▼ Intl. Nuclear Physics Conf., *Berkeley, CA*. L.S. Schroeder, Lawrence Berkeley Lab.; e-mail [INPC2001@lbl.gov](mailto:INPC2001@lbl.gov); [www.lbl.gov/~inpc2001/](http://www.lbl.gov/~inpc2001/).

**30-3** Nonneutral Plasma Physics Workshop, *La Jolla, CA*. C.F. Driscoll, Organizing Committee Chair, Univ. of California at San Diego, Physics Dept., 0319, 9500 Gilman Dr., La Jolla, CA 92093-0319; 858-534-2489; fax 858-534-0173; e-mail [fdriscoll@ucsd.edu](mailto:fdriscoll@ucsd.edu); <http://sdphca.ucsd.edu/NNP/>.

## AUGUST 2001

**5-9** ▼ 7th Intl. Colloquium on Atomic Spectra and Oscillator Strengths, *Belfast, Northern Ireland, UK*. A. Hibbert, Dept. of Applied Mathematics and Theoretical Physics, Queen's Univ., Belfast BT7 1NN, Northern Ireland, UK; 44-2890-273171; e-mail [a.hibbert@qub.ac.uk](mailto:a.hibbert@qub.ac.uk); [www.am.qub.ac.uk/asos7](http://www.am.qub.ac.uk/asos7).

**5-9** 10th Intl. Conf. on Environmental Degradation of Materials in Nuclear Power Systems-Water Reactors, *South Lake Tahoe, NV*. NACE Intl., P.O. Box 218340, Houston, TX 77218-8340; 281-228-6223; e-mail [msd@mail.nace.org](mailto:msd@mail.nace.org); [www.nace.org](http://www.nace.org).

**5-9** Conf. on Microscopy and Microanalysis, *Long Beach, CA*. MSA Meeting Managers, 7000 W. Southwest Hwy., Chicago Ridge, IL 60415; 708-361-6045; fax 708-361-6166; e-mail [msa@tradeshownet.com](mailto:msa@tradeshownet.com); [www.mmconference.org/2001](http://www.mmconference.org/2001).

**6-8** 26th Intl. Thermal Conductivity Conf. and 14th Intl. Thermal Expansion Symposium, *Cambridge, MA*. Conf. Chair, ITCC 26/ITES 14, c/o Holometrix Micromet, 25 Wiggins Ave., Bedford, MA 01730; [itcc@holometrix.com](mailto:itcc@holometrix.com); [www.thermalconductivity.com](http://www.thermalconductivity.com).

**6-10** ▼ 6th Applied Diamond Conf./2nd Frontier Carbon Technology Joint Conf., *Auburn, AL*. [www.eng.auburn.edu/department/ee/ADC-FCT2001/index.htm](http://www.eng.auburn.edu/department/ee/ADC-FCT2001/index.htm).

**12-16** ▼ 13th Conf. on Crystal Growth and Epitaxy, *Burlington, VT*. T. Gentile, ACCGE-13 Secretariat, P.O. Box 3233, Thousand Oaks, CA 91359-0233; 805-492-7047; 805-492-4062; e-mail [aacg@lafn.org](mailto:aacg@lafn.org); [www.crystalgrowth.org/conferences/accge13/](http://www.crystalgrowth.org/conferences/accge13/).

**12-17** 10th Intl. Conf. on Phonon Scattering in Condensed Matter, *Hanover, NH*. Phonons 2001, Dept. of Physics and Astronomy, Dartmouth College, HB 6127, Hanover, NH 03755; e-mail [phonons@mac.dartmouth.edu](mailto:phonons@mac.dartmouth.edu); [www.dartmouth.edu/~phonon](http://www.dartmouth.edu/~phonon).

**12-17** ▼ Conf. on Novel Synthesis and Processing of Nanostructured Coatings for Protection Against Degradation, *Davos, Switzerland*. United Engineering Foundation, 3 Park Ave., 27th Floor, New York, NY 10016-5902; 212-591-7836; fax 212-591-7441; e-mail [engfnd@aol.com](mailto:engfnd@aol.com); [www.engfnd.org](http://www.engfnd.org).

**13-17** 10th Canadian Semiconductor Technology Conf., *Ottawa, Ontario, Canada*. M. Lanouette, Conf. Mgr., Conf. Services Office, Natl. Research Council Canada, Bldg. M-19, Ottawa, Ontario, Canada K1A 0R6; 613-993-0414; fax 613-993-7250; e-mail [marie.lanouette@nrc.ca](mailto:marie.lanouette@nrc.ca).

**19-23** ▼ 9th Intl. Symposium on Macromolecule Metal Complexes, *Brooklyn, NY*. N.L. Byerly, Div. of Polymer Chemistry, Virginia Tech, 410 Davidson Hall, MC 0279, Blacksburg, VA 24061; 540-231-3029; fax 540-231-2588; e-mail [nbyerly@vt.edu](mailto:nbyerly@vt.edu); [www.chem.umr.edu/~poly/poly.spon.html](http://www.chem.umr.edu/~poly/poly.spon.html).

**22-24** ▼ 12th U.S. Natl. Synchrotron Radiation Instrumentation Conf., *Madison, WI*. Univ. of Wisconsin Synchrotron Radiation Ctr., 3731 Schneider Dr., Stoughton, WI 53589; 608-877-2000; fax 608-877-2001; e-mail [SRI2001@src.wisc.edu](mailto:SRI2001@src.wisc.edu); [www.src.wisc.edu/SRI2001](http://www.src.wisc.edu/SRI2001).

**26-30** 7th Intl. Conf. on Advanced Materials, *Cancun, Mexico*. M.L. Marquina, Dept. de Física, Facultad de Ciencias, Univ. Nacional Autónoma de México, 04510 México, D.F.; e-mail [committee@icam2001.unam.mx](mailto:committee@icam2001.unam.mx); [www.icam2001.unam.mx](http://www.icam2001.unam.mx). **IUMRS**

**26-30** 222nd American Chemical Society Natl. Meeting, *Chicago, IL*. Dept. of Meetings, American Chemical Society, 1155-16th St., NW, Washington, DC 20036; 202-872-4396; fax 202-872-6128; e-mail [natlmtg@acs.org](mailto:natlmtg@acs.org).

**26-31** 13th European Conference on Chemical Vapor Deposition (EUROCV13), *Athens, Greece*. [www.imel.demokritos.gr/EUROCV13/Eurocvd13.html](http://www.imel.demokritos.gr/EUROCV13/Eurocvd13.html).

**27-31** Conf. on Recrystallization and Grain Growth, *Aachen, Germany*. D.A. Molodov, Inst. für Metallkunde und Metallphysik, RWTH Aachen, D-52056 Aachen, Germany; fax 49-241-888-8608; e-mail [ReX&GG@imm.rth-aachen.de](mailto:ReX&GG@imm.rth-aachen.de).

## SEPTEMBER 2001

**2-7** 200th Meeting of the Electrochemical Society and 52nd Meeting of the Intl. Society of Electrochemistry, *San Francisco, CA*. The Electrochemical Society, 65 S. Main St., Pennington, NJ 08534-2839; 609-737-1902; fax 609-737-2743; e-mail [ecs@electrochem.org](mailto:ecs@electrochem.org); [www.electrochem.org](http://www.electrochem.org).

**3-5** ▼ Intl. Workshop on Device Technology, *Brazil*. Israel Baumvol, Instituto de Física, Universidade Federal do Rio Grande do Sul, Av. Bento Gonçalves, 9500, 91509-900 Porto Alegre RS, Brazil; e-mail [high-k@ifufrs.br](mailto:high-k@ifufrs.br). **MRS.**

**3-7** ▼ 9th Intl. Conf. on Ion Sources, *Oakland, CA*. M. Condon, Conf. Administrator; 510-486-7135; fax 510-486-5788; e-mail [icis01@lbl.gov](mailto:icis01@lbl.gov); <http://icis01.lbl.gov>.

**3-7** ▼ 10th Intl. Meeting on Ferroelectricity, *Madrid, Spain*. C. M. Jiménez, Jefe del Dept. de Electrocerámica, Inst. de Cerámica y Vidrio, CSIC, 28500 Arganda de Rey, Madrid, Spain; 34-91-871-1800; fax 34-91-870-0550; e-mail [imf10@etsit.upm.es](mailto:imf10@etsit.upm.es); [www.imf10.etsit.upm.es](http://www.imf10.etsit.upm.es).

**3-7** 11th Intl. Conf. on Radiation Effects in Insulators, *Lisbon, Portugal*. Conf. Secretariat REI-11, Inst. Tecnológico e Nuclear, Estrada Nacional No. 10, 2686-953, Sacavém, Portugal; 351-21-994-6000; fax 351-21-994-1525; e-mail [REI-11@itn.pt](mailto:REI-11@itn.pt); [www.itn.pt/REI11/](http://www.itn.pt/REI11/).

**3-14** Conf. on Chemical Physics of Thin Film Deposition Processes for Micro- and Nano-Technologies, *Kaunas, Lithuania*. Y. Pauleau, CNRS-LEMED, B.P. 166, 25 Rue des Martyrs, 38042 Grenoble Cedex 9, France; 33-4-7688-1071; fax 33-4-7688-7945; e-mail [pauleau@polycnrs-gre.fr](mailto:pauleau@polycnrs-gre.fr); [www.polycnrs-gre.fr](http://www.polycnrs-gre.fr).

**5-8** ▼ 8th Biomedical Science and Technology Symposium, *Ankara, Turkey*. Dr. V. Hasirci, BIOMED 8, METU, Biological Sciences Dept., Ankara 06531, Turkey; 90-312-210-5180; fax 90-312-210-1289; e-mail [biomed@metu.edu.tr](mailto:biomed@metu.edu.tr); [www.bio.metu.edu.tr/~biomed/new\\_page\\_1.htm](http://www.bio.metu.edu.tr/~biomed/new_page_1.htm).

**7-12** ▼ Conf. on Electronic Structure of Solids and Surfaces, *Giens, France*. J. Hendekovic, European Science Foundation, 1 quai Lezay-Marnésia, F-67080 Strasbourg Cedex, France; 33-388-76-71-35; fax 33-388-36-69-87; [www.esf.org/euresco](http://www.esf.org/euresco).

**8-13** ▼ Conf. on Photovoltaic Devices: High-Efficiency Solar Cells, *Tomar, Portugal*. J. Hendekovic, European Science Foundation, 1 quai Lezay-Marnésia, 67080 Strasbourg Cedex, France; 33-388-76-71-35; fax 33-388-36-69-87; e-mail [euresco@esf.org](mailto:euresco@esf.org); [www.esf.org/euresco](http://www.esf.org/euresco).

**9-13** Power Quality Conf., *Rosemont (Chicago), IL*. Power Quality 2001, 2472 Eastman Ave. #33, Ventura, CA 93003-5792; fax 805-650-7054; e-mail [linda@powersystems.com](mailto:linda@powersystems.com); [www.powersystems.com/cfp/2001/pq.html](http://www.powersystems.com/cfp/2001/pq.html).

**9-14** 10th Intl. Conf. on II-VI Compounds, *Bremen, Germany*. H. Heinke, Secretary II-VI 2001, Inst. for Solid State Physics, Univ. of Bremen, FB1, P.O. Box 330 440, D-28334 Bremen, Germany; 49-421-218-7453; fax 49-421-218-4581; e-mail [II-VI2001@physik.uni-bremen.de](mailto:II-VI2001@physik.uni-bremen.de); [www.II-VI2001.uni-bremen.de](http://www.II-VI2001.uni-bremen.de).

**9-14** Conf. on Surface Modification of Materials by Ion Beams, *Marburg, Germany*. D. Rueck, Gesellschaft für Schwerionenforschung mbH, Planckstrasse 1, D-64291 Darmstadt, Germany; 49-6159-71-2603; fax 49-6159-71-2505; e-mail [D.Rueck@gsf.de](mailto:D.Rueck@gsf.de); [www.gsi.de](http://www.gsi.de).

**9-14** ▼ Intl. Gordon Research Conf. on Superconductivity, *Oxford, UK*. Gordon Research Conferences, P.O. Box 984, West Kingston, RI 02892-0984; 401-783-4011; fax 401-783-7644; e-mail [grc@grcmail.grc.uri.edu](mailto:grc@grcmail.grc.uri.edu); [www.grc.uri.edu](http://www.grc.uri.edu).

**11-14** Intl. Symposium on High-Performance Liquid Phase Separation, *Kyoto, Japan*. N. Tanaka, Kyoto Inst. of Technology, Kyoto, Japan; e-mail [hplickit@ipc.kit.ac.jp](mailto:hplickit@ipc.kit.ac.jp).

**12-14** 2nd Intl. Conf. on High-Resolution and Magnetic Sector Field ICP-MS, *Vienna, Austria*. T. Prohaska, Inst. für Chemie, Univ. für Bodenkultur, BOKU-Wien, Muthgasse 18, A-1190 Vienna, Austria; 43-1-36006-6092; fax 43-1-36006-6059-092; e-mail [prohaska@mail.boku.ac.at](mailto:prohaska@mail.boku.ac.at); [www.boku.ac.at/chemie/conferences/conferences.htm](http://www.boku.ac.at/chemie/conferences/conferences.htm).

**12-14** ▼ European Society for Biomaterials Conf., *London, UK*. D. Gornall, Biomaterials 2001 Secretariat, IRC in Biomedical Materials, Queen Mary Univ. of London, Mile End Rd., London E1 4NS, UK; 44-20-7882-5318; fax 44-20-8983-1799; e-mail [ESB2001@gmw.ac.uk](mailto:ESB2001@gmw.ac.uk); [www.irc-biomed-materials.gmw.ac.uk](http://www.irc-biomed-materials.gmw.ac.uk).

**12-14** Jornadas SAM-CONAMET 2001, *Pasodas, Argentina*. Jornadas SAM-CONAMET 2001, Facultad de Ciencias Exactas, Químicas y Naturales, Azara 1552, 3300 Posadas, Misiones, Argentina. **MRS-A.**

**14-16** 4th Intl. Conf. on Peer Review in Biomedical Publication, *Barcelona, Spain*. A. Flanagin, JAMA, 515 N. State St., Chicago, IL 60610; 312-464-2432; fax 312-464-5824; e-mail [jama-peer@ama-assn.org](mailto:jama-peer@ama-assn.org).

**16-21** ▼ 11th Intl. Workshop on Glasses, Ceramics, Hybrids, and Nanocomposites from Gels, *Padova, Italy*. Workshop Sol-Gel 2001, c/o Dipartimento di Ingegneria Meccanica, Settore Materiali, via Marzolo 9, 35131 Padova, Italy; 39-49-827-5514; fax 39-49-8275505; e-mail [solgel01@ux1.unipd.it](mailto:solgel01@ux1.unipd.it).

**16-21** Intl. Conf. on Hydrogen Effects on Material Behavior and Corrosion Deformation Interactions, *Moran, WY*. N.R. Moody, SNL, P.O. Box 969, MS-9404, Livermore, CA 94551; 925-294-2622; fax 925-294-3410. **Endorsed.**

**16-21** ▼ Intl. Gordon Research Conf. on Solid State Chemistry II, *Oxford, UK*. Gordon Research Conferences, P.O. Box 984, West Kingston, RI 02892-0984; 401-783-4011; fax 401-783-7644; e-mail [grc@grcmail.grc.uri.edu](mailto:grc@grcmail.grc.uri.edu); [www.grc.uri.edu](http://www.grc.uri.edu).

**17-20** 5th Intl. Airborne Remote Sensing Conf., *San Francisco, CA*. Veridian Systems Intl. Conferences, P.O. Box 134008, Ann Arbor, MI 48113-4008; 734-994-1200; fax 734-994-5123; [www.irim-int.com/CONF/IARSC.html](http://www.irim-int.com/CONF/IARSC.html).

**17-21** Conf. on X-Ray and Neutron Capillary Optics, *Zvenigorod, Russia*. SPIE, P.O. Box 10, Bellingham, WA 98227-0010; 360-676-3290; fax 360-647-1445; e-mail [spie@spie.org](mailto:spie@spie.org); [www.spie.org](http://www.spie.org).

**17-21** Intl. Symposium on Advanced Materials, *Islamabad, Pakistan*. A.A. Mazhar, Secretary Symposium, A.Q. Khan Res. Lab., Kahuta, P.O. Box 905, Rawalpindi, Pakistan; 92-51-928-0541; fax 92-51-928-0542; e-mail [compudiv@asb.paknet.com.pk](mailto:compudiv@asb.paknet.com.pk).

**18-21** Intl. Conf. on Advances in Materials and Processing Technologies, *Madrid, Spain*. AMPT'01 Congress Secretariat, Fundación Univ. Carlos III, CON-GREGA, Avda. de la Universidad 30, 28911 Leganés, Spain; 34-91-624-9142; fax 34-91-624-9147; e-mail [congrega@fund.uc3m.es](mailto:congrega@fund.uc3m.es); e-mail [ampt01@ing.uc3m.es](mailto:ampt01@ing.uc3m.es).

**19-21** ▼ **MEMS: Materials Issues Workshop**, *Miami, FL*. Materials Research Society, 506 Keystone Dr., Warrendale, PA 15086-7573; 724-779-3003; fax 724-779-8313; e-mail info@mrs.org; www.mrs.org. **MRS**.

**20-21** ▼ 9th Intl. Activated Carbon Conf., *Pittsburgh, PA*. H. Nowicki, PACS, Inc., 409 Meade Dr., Coraopolis, PA 15108; 800-367-2587; fax 724-457-1214; e-mail hnpacs@aol.com; http://members.aol.com/hnpacs/pacs.htm.

**23-25** ▼ 3rd Intl. Symposium on Structural Intermetallics, *Jackson Hole, WY*. K.J. Hemker, Johns Hopkins Univ., Dept. of Mechanical Engineering, 12 Latrobe Hall, 3400 N. Charles St., Baltimore, MD 21218; 410-516-4489; fax 410-516-7254; e-mail hemker@jhu.edu.

**23-26** ▼ Engineering Materials Conf., *Melbourne, Australia*. Secretariat, IMEA Head Office; 61-3-9326-7266; fax 61-3-9326-7272; e-mail imea@mateng.asn.au; www.mateng.asn.au/engmat2001.

**23-26** TMS Fall Extraction and Process Metallurgy Meeting, *San Diego, CA*. M. Cross, School of Computing and Mathematical Science, Univ. of Greenwich, Woolwich Campus, Wellington St., Woolwich, London SE18 6PF, UK; 44-208-331-8702; fax 44-208-331-8695.

**23-27** 3rd Intl. Symposium on Structural Intermetallics, *Jackson Hole, WY*. TMS, 184 Thorn Hill Rd., Warrendale, PA 15086; 724-776-9000; fax 724-776-3770; e-mail tmsgeneral@tms.org; www.tms.org/meetings/.

**23-27** 6th World Congress of Chemical Engineering, *Melbourne, Australia*. Meetings Dept., American Inst. of Chemical Engineers, 3 Park Ave., New York, NY 10016-5991; 212-591-7338; fax 212-591-8894; e-mail meetmail@aiche.org; www.aiche.org/conferences/.

**23-27** ACS Southeast Regional Meeting, *Savannah, GA*. American Chemical Society, 1115 16th St., NW, Washington, DC 20036; 202-872-4600; fax 202-872-4615; e-mail help@acs.org; www.acs.org.

**24-28** ▼ 9th Intl. Conf. on Defects: Recognition, Imaging, and Physics in Semiconductors, *Rimini, Italy*. C. Frigeri, CNR-MASPEC, Parco Area delle Scienze, 37/A, Fontanini, 43010 Parma, Italy; 39-521-269-235; fax 39-521-269-206; e-mail frigeri@maspec.bo.cnr.it; www.maspec.bo.cnr.it/ut/d11200/NEWS/drip9/drip9.html.

**30-5** ▼ Conf. on Nonstoichiometric Ceramics and Intermetallics, *Barga, Italy*. United Engineering Foundation, 3 Park Ave., 27th Floor, New York, NY 10016-5902; 212-591-7836; fax 212-591-7441; e-mail engfnd@aol.com; www.engfnd.org.

## OCTOBER 2001

**1-3** Conf. on Fine Powder Processing, *State College, PA*. C. Knobloch, Particle Materials Ctr., The Pennsylvania State Univ., 225 Materials Research Lab., University Park, PA 16802-4801; 814-863-6156; fax 814-863-9704; e-mail clk18@psu.edu; conferenceinfo@cde.psu.edu.

**1-3** ▼ Intl. Conf. on Process Modeling and Powder Metallurgy & Particulate Materials, *Irvine, CA*. Metal Power Industries Federation, 105 College Rd. East, Princeton, NJ 08540-6692; 609-452-7700; fax 609-987-8523; e-mail info@mpif.org; www.mpi.org.

**1-4** ▼ Materialica Conf., *Munich, Germany*. Messe München GmbH, Zentralbereich Presse- und Öffentlichkeitsarbeit, Pressereferat MATERIALICA, Messegelände, D-81823 München, Germany; 49-89-9-49-20650; fax 49-89-9-49-20659; e-mail info@materialica.de; www.materialica.de.

**3-5** Conf. on Photomask Technology and Management, *Monterey, CA*. SPIE, P.O. Box 10, Bellingham, WA 98227-0010; 360-676-3290; fax 360-647-1445; e-mail spie@spie.org; www.spie.org.

**5-12** 28th Annual Conf. on Federation of Analytical Chemistry and Spectroscopy Societies, *Detroit, MI*. C. Lilly, FACSS Natl. Office, 1201 Don Diego Ave., Santa Fe, NM 87505; 508-820-1648; fax 505-989-1073; e-mail jsjoberg@trail.com; http://facss.org/info.html.

**7-10** ▼ Conf. on Advances in Polyolefins III, *Sonoma, CA*. J.E. McGrath, Dept. of Chemistry, Virginia Tech, Blacksburg, VA 24061; 540-231-5976; fax 540-231-8517; e-mail jmcgrath@vt.edu; www.chem.umr.edu/~poly/poly\_spon.html.

**7-12** Conf. on Structural Ceramics and Ceramic Composites for High-Temperature Applications, *Seville, Spain*. United Engineering Foundation, 3 Park Ave., New York, NY 10016-5902; 212-591-7836; fax 212-591-7441; e-mail engfnd@aol.com; www.engfnd.org.

**9-11** ▼ Advanced Metallization Conference (AMC), *Montreal, Canada*. Continuing Education in Engineering, UC Berkeley Extension, 1995 University Avenue, Berkeley, CA 94720-7010, USA; 510-642-4151; fax 510-642-6027; e-mail course@unx.berkeley.edu; www.unex.berkeley.edu/eng/metal.

**10-13** ACS Midwest Regional Meeting, *Lincoln, NE*. American Chemical Society, 1115 16th St., NW, Washington, DC 20036; 202-872-4600; fax 202-872-4615; e-mail help@acs.org; www.acs.org.

**13** ▼ 2nd Dartmouth Molecular Materials Symposium, *Hanover, NH*. Dartmouth Molecular Materials Group, Dartmouth College, 6128 Burke Lab., Hanover, NH 03755-3564; 603-646-2710; fax 603-646-3946; e-mail dmmg@dartmouth.edu; www.dartmouth.edu/~dmmg/Oct.Symposium.html.

**14-18** 6th Intl. Symposium on Self-Propagating High-Temperature Synthesis, *Haifa, Israel*. Dept. of Materials Engineering, TECHNION-Israel Inst. of Technology, Technion City, Haifa 32000, Israel; 972-4-829-2112; fax 972-4-832-1978; e-mail gutmanas@tx.technion.ac.il; www.technion.ac.il/technion/materials.

**14-18** ▼ 17th Interdisciplinary Laser Science Conf., *Long Beach, CA*. OSA Conf. Services, 2010 Massachusetts Ave. N.W., Washington, DC 20036-1023; 202-223-0920; fax 202-416-6100; e-mail confserv@osa.org; www.osa.org/annual.

**15-18** 20th Intl. Congress on Applications of Lasers and Electro-Optics, *Jacksonville, FL*. B. Cohen, Laser Inst. of America, 13501 Ingenuity Dr., Ste. 128, Orlando, FL 32826; 407-380-1553; fax 407-380-5588; e-mail lia@laserinstitute.org; www.icaleo.org.

**16-17** ▼ Conf. on Power Transmission Components—Advances in High-Performance Powder Metallurgy Applications, *Ypsilanti, MI*. Metal Power Industries Federation, 105 College Rd. East, Princeton, NJ 08540-6692; 609-452-7700; fax 609-987-8523; e-mail info@mpif.org; www.mpi.org.

**17-20** ACS Southwest Regional Meeting, *San Antonio, TX*. American Chemical Society, 1115 16th St., NW, Washington, DC 20036; 202-872-4600; fax 202-872-4615; e-mail help@acs.org; www.acs.org.

**17-20** Fall Meeting of the APS Division of Nuclear Physics, *Mau, HI*. American Physical Society, One Physics Ellipse, College Park, MD 20740-3844; 301-209-3200; fax 301-209-0865; www.aps.org.

**21-25** Intl. Workshop on Flow and Fracture of Advanced Glasses, *Rennes, France*. V. Keryvin, Univ. Rennes1, Larmaur, 35042 Rennes, France; 33-2-9928-2685; fax 33-2-9928-1600; e-mail vincent.keryvin@univ-rennes1.fr; www.larmaur.univ-rennes1.fr/ffag.

**22-23** North American Orbital Welding Symposium, *Rosemont, IL*. Astro Arc Polysoude, W133 N5138 Campbell Dr., Menomonee Falls, WI 53051; 414-783-2720; fax 414-783-2730; e-mail mbaer@polysoude.com; www.polysoude.com.

**22-24** ▼ 4th Biennial Conf. on Emulsion Polymers/Polymer Colloids, *Orlando, FL*. Inst. of Materials Science, Div. of Program Organization, P.O. Box 369, New Paltz, NY 12561; 845-255-0757; fax 845-255-0978; e-mail info@ims-np.org; http://ims-hp.org.

**22-24** Powder Metallurgy Congress, *Nice, France*. European Powder Metallurgy Assoc., Old Bank Bldgs., Bellstone, Shrewsbury SY1 1HU, UK; 44-1743-248-899; fax 44-1743-362-968; e-mail info@epma.com; www.epma.com.

**22-26** OSA Annual Meeting and 16th Interdisciplinary Laser Science Conf., *Providence, RI*. Optical Society of America, Conf. Services Dept., 2010 Massachusetts Ave., NW, Washington, DC 20036-1023; 202-223-8130; fax 202-223-1096; e-mail confserv@osa.org; www.osa.org/mtg\_conf/annual.

**25-26** ▼ 8th Sampling, On-Site Analysis, and Sample Preparation Conf., *Pittsburgh, PA*. B. Sherman, PACS, Inc., 409 Meade Dr., Coraopolis, PA 15108-9616; 800-367-2587; fax 724-457-1214; e-mail hnpacs@aol.com; http://members.aol.com/hnpacs/pacs.htm.

**28-31** 43rd Mechanical Working and Steel Processing Conf., *Charlotte, NC*. Iron & Steel Society, 186 Thorn Hill Rd., Warrendale, PA 15086-7528; 724-776-1535; fax 724-776-0430; e-mail custserv@iss.org; www.iss.org.

**28-31** ACS Western Regional Meeting, *Santa Barbara, CA*. American Chemical Society, 1115 16th St., NW, Washington, DC 20036; 202-872-4600; fax 202-872-4615; e-mail help@acs.org; www.acs.org.

**28-2** Intl. Conf. on Silicon Carbide and Related Materials, *Tsukuba, Japan*. H. Okumura, Electrochemical Lab., 1-1-4 Umezono, Tsukuba, Ibaraki 305-8565, Japan; www.icscrm2001.gr.jp/.

**29-2** 48th Natl. American Vacuum Society Symposium, *San Francisco, CA*. American Vacuum Society Natl. Office, 120 Walls St., 32nd Fl., New York, NY 10005; 212-248-0200; fax 212-248-0245; e-mail avsnyc@vacuum.org; www.vacuum.org.

**29-2** Meeting of the APS Div. of Plasma Physics, *Long Beach, CA*. APS Headquarters, One Physics Ellipse, College Park, MD 20740-3844; 301-209-3200; fax 301-209-0865; e-mail meetings@aps.org; www.aps.org.

## NOVEMBER 2001

**4-8** 33rd Intl. SAMPE Technical Conf., *Seattle, WA*. Society for the Advancement of Material and Process Engineering, P.O. Box 2459, Covina, CA 91722-8459; 626-331-0616; fax 626-332-8929; e-mail sampereg@aol.com; www.sampe.org.

**4-8** Intl. Conf. on Advanced Ceramics and Glasses, *Mau, HI*. American Ceramic Society, P.O. Box 6136, Westerville, OH 43086-6136; 614-890-4700; fax 614-899-6109; e-mail info@acers.org; www.acers.org/meetings/.

**4-8** TMS Fall Meeting, *Indianapolis, IN*. TMS, 184 Thorn Hill Rd., Warrendale, PA 15086; 724-776-9000; fax 724-776-3770; e-mail weissp@tms.org; www.tms.org.

**4-9** AIChE Annual Meeting, *Reno, NV*. Meetings Dept., American Inst. of Chemical Engineers, 3 Park Ave., New York, NY 10016-5991; 212-591-7338; fax 212-591-8894; e-mail meetmail@aiche.org; www.aiche.org/conferences/.

**5-7** 2nd Intl. Symposium on Adhesion Aspects of Thin Films, *Newark, NJ*. R.H. Lacombe, Conf. Chairman, 3 Hammer Dr., Hopewell Junction, NY 12533; 845-226-1393; fax 212-656-1016; e-mail rhl@mstconf.com; http://mstconf.com/adhtf2.htm.

**7-9** 3rd Intl. Symposium on Adhesion Measurement of Thin Films and Coatings, *Newark, NJ*. R.H. Lacombe, Conf. Chairman, 3 Hammer Dr., Hopewell Junction, NY 12533; 845-226-1393; fax 212-656-1016; e-mail rhl@mstconf.com; http://mstconf.com/adhmeas3.htm.

**11-14** 59th Electric Furnace Conf., *Phoenix, AZ*. The American Ceramic Society, P.O. Box 6136, Westerville, OH 43086-6136; 614-794-5890; fax 614-899-6109; e-mail customersvc@acers.org; www.ceramics.org.

**11-16** ▼ ASME Intl. Mechanical Engineering Congress, *New York, NY*. American Society of Mechanical Engineers, 3 Park Ave., New York, NY 10016-5990; 1-800-843-2763; e-mail [www.infocentral@asme.org](mailto:www.infocentral@asme.org); [www.asme.org](http://www.asme.org).

**11-16** ▼ Conf. on Integrating Materials Science into Engineering Structures and Devices, *Lake Arrowhead, CA*. United Engineering Foundation, 3 Park Ave., 27th Floor, New York, NY 10016-5902; 212-591-7836; fax 212-591-7441; e-mail [engfnd@aol.com](mailto:engfnd@aol.com); [www.engfnd.org/engfnd/lar/html](http://www.engfnd.org/engfnd/lar/html).

**12-16** ▼ 45th Annual Magnetism and Magnetic Materials Conf., *Seattle, WA*. 2001 MMM Conf., Courtesy Associates, 2000 L St. N.W., Ste. 710, Washington, DC 20036; 202-973-8668; fax 202-973-8722; e-mail [magnetism@courtesyassoc.com](mailto:magnetism@courtesyassoc.com); [www.magnetism.org](http://www.magnetism.org).

**14-17** ▼ Conf. on Organic/Inorganic Hybrid Materials, *Sonoma, CA*. [www.chem.umn.edu/~poly/poly.spon.html](http://www.chem.umn.edu/~poly/poly.spon.html).

**26-30** MRS Fall Meeting, *Boston, MA*. Materials Research Society, 506 Keystone Drive, Warrendale, PA 15086-7573; 724-779-3003; fax 724-779-8313; e-mail [info@mrs.org](mailto:info@mrs.org); [www.mrs.org](http://www.mrs.org).

**27-30** ▼ Intl. Conf. on Accelerator and Large Experimental Physics, *San Jose, CA*. ICALEPCS 2001 Secretariat, Centennial Conferences, 4800 Baseline Rd., Ste. A-112, Boulder, CO 80303; 303-499-2299; fax 303-499-2599; e-mail [icalepcs@centennialconferences.com](mailto:icalepcs@centennialconferences.com); <http://icalepcs2001.slac.stanford.edu/>.

## DECEMBER 2001

**3-5** 2nd Intl. Symposium on Polyimides and Other High Temperature Polymers, *Newark, NJ*. R.H. Lacombe, Conf. Chairman, 3 Hammer Dr., Hopewell Junction, NY 12533; 845-226-1393; fax 212-656-1016; e-mail [rhl@mstconf.com](mailto:rhl@mstconf.com); <http://mstconf.com/polyim2.htm>.

**3-7** 10th Intl. Congress of Fracture, *Honolulu, HI*. A. Hill, ICF10 Congress Secretariat, Elsevier Science, The Boulevard, Langford Lane, Kidlington, Oxford OX5 1GB, UK; 44-1865-843-643; fax 44-1865-843-958; e-mail [a.richardson@elsevier.co.uk](mailto:a.richardson@elsevier.co.uk); [www.elsevier.com](http://www.elsevier.com).

**3-7** ▼ Pacific Polymer Federation Conf., *Oaxaca City, Mexico*. T. Ogawa, Inst. de Investigaciones en Materiales, UNAM, Ap. 70-360, CU, Coyoacan, Mexico DF 04510, Mexico; 52-5-622-4583; fax 52-5-616-1201; e-mail [ogawa@servidor.unam.mx](mailto:ogawa@servidor.unam.mx); [www.chem.umn.edu/~poly/poly.spon.html](http://www.chem.umn.edu/~poly/poly.spon.html).

**5-8** 3rd Intl. Symposium on Environmental Hydraulics, *Tempe, AZ*. R. Rankin, ISEH 2001 Secretary, Arizona State Univ., Dept. of Mechanical and Aerospace Engineering, P.O. Box 876106, Tempe, AZ 85287-6106; 480-965-3207; fax 480-965-1384; e-mail [iseh@enpop2.eas.asu.edu](mailto:iseh@enpop2.eas.asu.edu); [www1.eas.asu.edu/~iseh2001/](http://www1.eas.asu.edu/~iseh2001/).

**6-7** 8th Intl. Symposium on Metallized Plastics, *Newark, NJ*. R.H. Lacombe, Conf. Chairman, 3 Hammer Dr., Hopewell Junction, NY 12533; 845-226-1393; fax 212-656-1016; e-mail [rhl@mstconf.com](mailto:rhl@mstconf.com); <http://mstconf.com/metalplas8.htm>.

**11-15** 4th Pacific Rim Intl. Conf. on Advanced Materials and Processing, *Honolulu, HI*. S. Hanada, Tohoku Univ., Inst. for Materials Research, Katahira 2-1-1, Aoba-ku, Sendai 980-8577, Japan; 81-22-215-2115; fax 81-22-215-2116; e-mail [ccpricm4@imr.tohoku.ac.jp](mailto:ccpricm4@imr.tohoku.ac.jp).

## JANUARY 2002

**6-11** 13th Intl. Conf. on Ternary and Multinary Compounds, *Dead Sea, Israel*. D. Cahen, Dept. of Materials and Interfaces, Weizmann Inst. of Science, Rehovot, Israel 76100; 972-0-89-34-2246; fax 972-0-89-34-4139; e-mail [david.cahen@weizmann.ac.il](mailto:david.cahen@weizmann.ac.il); [www.weizmann.ac.il/material/](http://www.weizmann.ac.il/material/).

**6-12** Winter Conf. on Plasma Spectrochemistry, *Scottsdale, AZ*. R. Barnes, ICP Information Newsletter, Inc., P.O. Box 666, Hadley, MA 01003-0666; 413-256-8942; fax 413-256-3746; e-mail [winterconf@chem.umass.edu](mailto:winterconf@chem.umass.edu); [www.chem.umass.edu/WinterConf2002](http://www.chem.umass.edu/WinterConf2002).

## FEBRUARY 2002

**1-3** ▼ Intl. Conf. on Advances in Materials and Materials Processing, *Kharagpur, India*. Dept. of Metallurgical and Materials Engineering, Indian Inst. of Technology, Kharagpur 721 302, India; 91-3222-82280; fax 91-3222-55303; e-mail [icamp@metal.iitkgp.ernet.in](mailto:icamp@metal.iitkgp.ernet.in).

**17-21** TMS Annual Meeting, *Seattle, WA*. TMS, 184 Thorn Hill Rd., Warrendale, PA 15086; 724-776-9000; fax 724-776-3770; e-mail [weissp@tms.org](mailto:weissp@tms.org); [www.tms.org/meetings/](http://www.tms.org/meetings/).

## MARCH 2002

**2-3** Conf. on Film Formation: Mechanism, Properties, and Characterization, *Hilton Head, SC*. Inst. of Materials Science, Div. of Program Organization, P.O. Box 369, New Paltz, NY 12561; 914-255-0757; fax 914-255-0978; e-mail [info@ims-np.org](mailto:info@ims-np.org); <http://ims-np.org/>.

**2-3** Conf. on Polymer Degradation and Stabilization, *Hilton Head, SC*. Inst. of Materials Science, Div. of Program Organization, P.O. Box 369, New Paltz, NY 12561; 914-255-0757; fax 914-255-0978; e-mail [info@ims-np.org](mailto:info@ims-np.org); <http://ims-np.org/>.

**4-6** 4th Biennial Conf. on Polymer Stabilizers and Modifiers, *Hilton Head, SC*. Inst. of Materials Science, Div. of Program Organization, P.O. Box 369, New Paltz, NY 12561; 914-255-0757; fax 914-255-0978; e-mail [info@ims-np.org](mailto:info@ims-np.org); <http://ims-np.org/>.

**4-6** Conf. on Film Formation: Science and Technology, *Hilton Head, SC*. Inst. of Materials Science, Div. of Program Organization, P.O. Box 369, New Paltz, NY 12561; 914-255-0757; fax 914-255-0978; e-mail [info@ims-np.org](mailto:info@ims-np.org); <http://ims-np.org/>.

**18-22** APS March Meeting, *Indianapolis, IN*. American Physical Society, One Physics Ellipse, College Park, MD 20740-3844; 301-209-3200; fax 301-209-0865; e-mail [meetings@aps.org](mailto:meetings@aps.org); [www.aps.org](http://www.aps.org).

**18-22** Intl. Solvent Extraction Conf., *Cape Town, South Africa*. Conf. Secretariat, Private Bag X3015, Randburg 2125, South Africa; 27-11-709-4255; fax 27-11-709-4326; e-mail [isec2002@mintek.co.za](mailto:isec2002@mintek.co.za); [www.isec2002.org.za](http://www.isec2002.org.za).

## APRIL 2002

**1-5** MRS Spring Meeting, *San Francisco, CA*. Materials Research Society, 506 Keystone Dr., Warrendale, PA 15086-7573; 724-779-3003; fax 724-779-8313; e-mail [info@mrs.org](mailto:info@mrs.org); [www.mrs.org](http://www.mrs.org).

**28-1** 104th ACerS Annual Meeting, *St. Louis, MO*. The American Ceramic Society, P.O. Box 6136, Westerville, OH 43086-6136; 614-890-4700; fax 614-899-6109; e-mail [info@acers.org](mailto:info@acers.org); [www.ceramics.org](http://www.ceramics.org).

## MAY 2002

**12-17** ▼ 201st Meeting of the Electrochemical Society, *Philadelphia, PA*. The Electrochemical Society, 65 S. Main St., Pennington, NJ 08534-2839; 609-737-1902; fax 609-737-2743; e-mail [ecs@electrochem.org](mailto:ecs@electrochem.org); [www.electrochem.org](http://www.electrochem.org).

**27-29** ▼ 7th European Symposium on Polymer Blends, *Lyon-Villeurbanne, France*. Secretariat, 7th European Symposium on Polymer Blends, Lab. des Matériaux Macromoléculaires, Bat J, Verne,

INSA Lyon, 20 Ave. Albert Einstein, 69621, Villeurbanne Cedex, France; 33-4-72-43-8527; e-mail [polymerblends@insa-lyon.fr](mailto:polymerblends@insa-lyon.fr); [www.insa-lyon.fr/polymer\\_blends/index.htm](http://www.insa-lyon.fr/polymer_blends/index.htm).

## JUNE 2002

**10-14** 8th Intl. Conf. on Electronic Materials, *Xi'an, China*. J. Cheng; 86-10-6894-4280; fax 86-10-6842-8640; e-mail [cmrsec@public.bta.net.cn](mailto:cmrsec@public.bta.net.cn); [www.c-mrs.org.cn/icem2002/](http://www.c-mrs.org.cn/icem2002/). C-MRS.

**16-20** Intl. Cryogenic Materials Conf., *Xi'an, China*. Y. Feng, Northwest Inst. for Non-ferrous Metal Research, P.O. Box 51, Xi'an, Shaanxi 710016, China; 86-29-623-1079; fax 86-29-623-1103; e-mail [smrc@pub.xaonline.com](mailto:smrc@pub.xaonline.com).

**23-26** ▼ Intl. Conf. on Thermomechanical Processing, *Sheffield, UK*. Thermomechanical Processing: Mechanics, Microstructure, and Control, c/o IMPETUS Admin. Office, Univ. of Sheffield, Sir Frederick Mappin Bldg., Mappin St., Sheffield S1 3JD, UK; 44-114-222-6018; fax 44-114-222-6015; e-mail [tpmm@sheffield.ac.uk](mailto:tpmm@sheffield.ac.uk); [http://dyn052176.shef.ac.uk/conference\\_2002](http://dyn052176.shef.ac.uk/conference_2002).

**23-28** 11th Intl. Meeting on Lithium Batteries, *Monterey, CA*. IMLB 11 Conf. Secretariat, c/o The Electrochemical Society, Inc., 65 S. Main St., Pennington, NJ 08534-2839; 609-737-1902; fax 609-737-2743; e-mail [ecs@electrochem.org](mailto:ecs@electrochem.org); [www.electrochem.org/meetings/011/imib11.html](http://www.electrochem.org/meetings/011/imib11.html).

## JULY 2002

**1-5** Conf. on Coatings Science and Technology, *Athens, Greece*. Inst. of Materials Science, Div. of Program Organization, P.O. Box 369, New Paltz, NY 12561; 914-255-0757; fax 914-255-0978; e-mail [info@ims-np.org](mailto:info@ims-np.org); <http://ims-np.org/>.

**1-5** Intl. Conf. on Fuel Cells, *Lucerne, Switzerland*. European Fuel Cell Forum, P.O. Box 99, CH-5452 Oberrohrdorf, Switzerland; 41-56-496-7292; fax 41-56-496-4412; e-mail [info@efcf.com](mailto:info@efcf.com); [www.efcf.com](http://www.efcf.com).

**14-18** ▼ 13th Intl. Symposium on Transport Phenomena, *Victoria, BC, Canada*. S. Dost, ISTEP-13, Dept. of Mechanical Engineering, Univ. of Victoria, Victoria, BC, Canada V8W 3P6; 250-721-8898; fax 250-721-6294; e-mail [istp13@uvic.ca](mailto:istp13@uvic.ca); [www.istp13.uvic.ca](http://www.istp13.uvic.ca).

**29-2** 26th Intl. Conf. on the Physics of Semiconductors, *Edinburgh, Scotland*. Conf. Dept., ICPS2002, Inst. of Physics, 76 Portland Place, London W1B 1NT, England; 44-20-7470-4800; fax 44-20-7470-4900; [www.icps2002.org](http://www.icps2002.org).

## SEPTEMBER 2002

**8-12** 6th Intl. Meeting on Magnetic Resonance in Porous Media, *Ulm, Germany*. [www.uni-ulm.de/nmr/mrpm6/early\\_notification.htm](http://www.uni-ulm.de/nmr/mrpm6/early_notification.htm).

**24-27** 3rd World Congress on Emulsions, *Lyon, France*. CME, 50 Place Marcel Pagnol, 92100 Boulogne-Billancourt, France; 33-147-617-689; fax 33-147-617-465; e-mail [alain.lecoroller@wanadoo.fr](mailto:alain.lecoroller@wanadoo.fr); [www.cme-emulsion.com](http://www.cme-emulsion.com).

## OCTOBER 2002

**6-10** ▼ TMS Fall Meeting, *Columbus, OH*. TMS Programming Dept., 184 Thorn Hill Rd., Warrendale, PA 15086; 724-776-9000; fax 724-776-3770; e-mail [ckobert@tms.org](mailto:ckobert@tms.org); [www.tms.org](http://www.tms.org).

**20-25** ▼ 202nd Meeting of the Electrochemical Society, *Salt Lake City, UT*. The Electrochemical Society, 65 S. Main St., Pennington, NJ 08534-2839; 609-737-1902; fax 609-737-2743; e-mail [ecs@electrochem.org](mailto:ecs@electrochem.org); [www.electrochem.org](http://www.electrochem.org).

## NOVEMBER 2002

**11-15** 44th Annual Meeting of the APS Division of Plasma Physics, *Orlando, FL*. American Physical Society, One Physics Ellipse, College Park, MD 20740-3844; 301-209-3200; fax 301-209-0865; e-mail [meetings@aps.org](mailto:meetings@aps.org); [www.aps.org](http://www.aps.org).

## DECEMBER 2002

**2-6** MRS Fall Meeting, *Boston, MA*. Materials Research Society, 506 Keystone Dr., Warrendale, PA 15086-7573; 724-779-3003; fax 724-779-8313; e-mail [info@mrs.org](mailto:info@mrs.org); [www.mrs.org](http://www.mrs.org).